

Waterproof D-SUB Solder Type

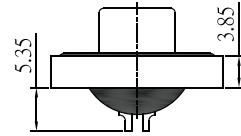
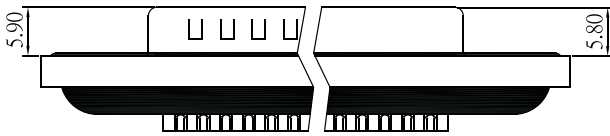
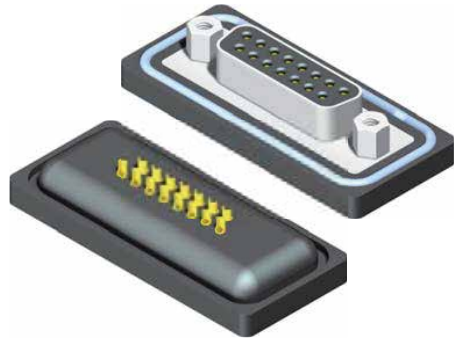
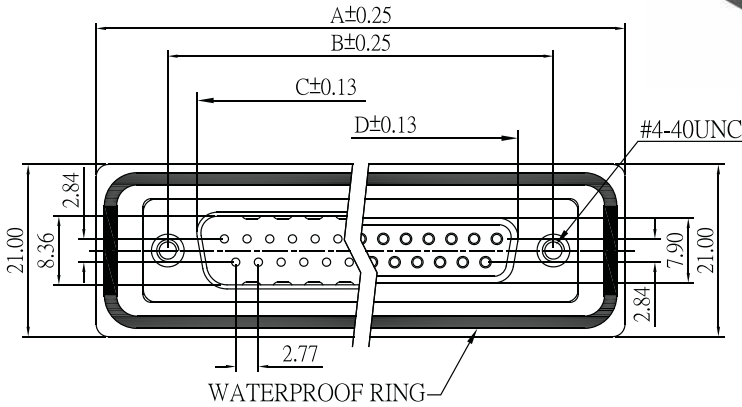
Specifications

Current Rate: 5 AMP
 Insulation Resistance: 5000MΩ Min.
 Contact Resistance: 10mΩ Max.
 Dielectric Voltage: AC 300V /ram 50Hz
 Operation Temperature: -55°C to +85°C

Material

Terminal: Copper Alloy.
 Insulator: PBT
 Temperature Plastic

No. of Contacts	Dim. A	Dim. B	Dim. C	Dim. D
9	39.40	24.99	16.92	16.33
15	47.70	33.30	25.25	24.66
25	64.50	47.04	38.96	38.38



Waterproof D-SUB Dip Type

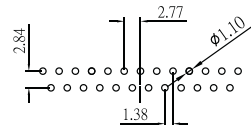
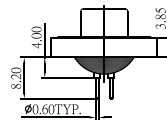
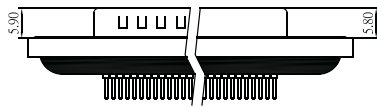
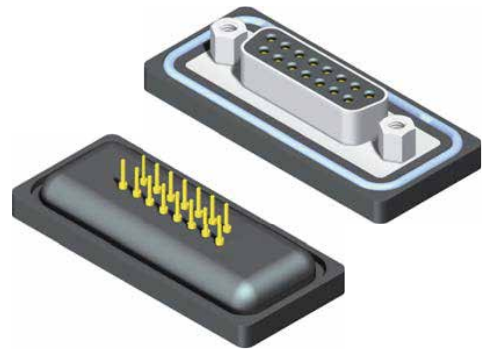
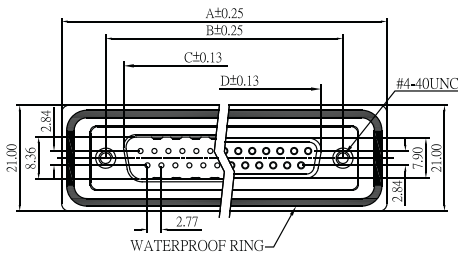
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Recommended PCB Layout
 (PCB TOLERANCE ±0.05)

ORDER INFORMATION

